

42390.P10889



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Vu, et al.

Serial No.: 09/884,595

Filed: June 18, 2001

For: Microelectronic Substrates With
Integrated Devices

Examiner: A. Williams

Group Art Unit: 2826

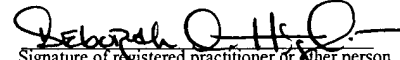
Attorney Docket No.: 42390.P10889

Confirmation No.: 3197

CERTIFICATE OF MAILING

I hereby certify that this paper or fee along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner of Patents, P.O. 1450, Alexandria, VA 22313-1450.

12/22/03
Date of Deposit


Signature of registered practitioner or other person
having reasonable basis to expect mailing to occur
on date of deposit shown pursuant to 37 C.F.R. §
1.8(a)(1)(ii)

DEBORAH L. HIGMAN
Typed/printed name of person whose signature is
contained above

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed August 22, 2003, with the time for response
having been extended by one month, please amend the above-referenced application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this
paper.

Amendments to the Drawings begin on page 22 of this paper and include an attached new drawing.

Remarks/Arguments begin on page 23 of this paper.

RECEIVED
JAN - 8 2004
TECHNOLOGY CENTER 2800